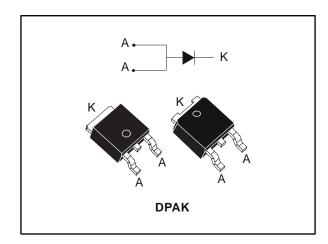
FERD15S50S



50 V field-effect rectifier diode

Datasheet - production data



Features

- ST advanced rectifier process
- Stable leakage current over reverse voltage
- Low forward voltage drop
- High frequency operation
- ECOPACK®2 compliant component for DPAK on demand

Description

This single rectifier is based on a proprietary technology that achieves the best in class V_F/I_R trade-off for a given silicon surface.

Packaged in DPAK, this device is intended to be used in rectification and freewheeling operations in power supplies.

Table 1: Device summary

Symbol	Value
I _{F(AV)}	15 A
V _{RRM}	50 V
V _F (typ.)	0.31 V
T _j (max.)	150 °C

Characteristics FERD15S50S

1 Characteristics

Table 2: Absolute ratings (limiting values at 25 °C, unless otherwise specified, anode terminals short-circuited)

Symbol	Parameter	Value	Unit	
V _{RRM}	Repetitive peak reverse voltage	50	V	
I _{F(RMS)}	Forward rms current	25	Α	
I _{F(AV)}	Average forward current δ = 0.5, square wave $T_C = 130 ^{\circ}C$		15	Α
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$		100	Α
T _{stg}	Storage temperature range	-65 to +175	°C	
Tj	Maximum operating junction temperature (1)	150	°C	

Notes:

Table 3: Thermal resistance parameters

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	1.4	°C/W

Table 4: Static electrical characteristics (anode terminals short circuited)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
	I _R ⁽¹⁾ Reverse leakage current	T _j = 25 °C	V _R = 35 V	-		470	μΑ
I- (1)		T _j = 125 °C		-	16	32	mA
IR''		T _j = 25 °C	V _R = V _{RRM}	-	250	650	μΑ
		T _j = 125 °C		-	20	40	mΑ
		T _j = 25 °C	I _F = 5 A	-	0.36		
		T _j = 125 °C		-	0.31	0.36	
V _F ⁽²⁾ Forward voltage drop	Forward valtage drap	T _j = 25 °C	I _F = 10 A	-	0.43	0.48	V
	v _F / Forward voltage drop	T _j = 125 °C		-	0.42	0.46	V
		T _j = 25 °C	I _F = 15 A	-	0.49		
		T _j = 125 °C		-	0.49	0.55	

Notes:

To evaluate the maximum conduction losses use the following equation:

$$P = 0.25 \text{ x } I_{F(AV)} + 0.02 \text{ x } I_{F^2(RMS)}$$

 $^{^{(1)}(}dP_{tot}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

 $^{^{(1)}\}text{Pulse}$ test: t_p = 5 ms, δ < 2%

 $^{^{(2)}}$ Pulse test: t_p = 380 μ s, δ < 2%

FERD15S50S Characteristics

Characteristics (curves) 1.1

Figure 1: Average forward power dissipation

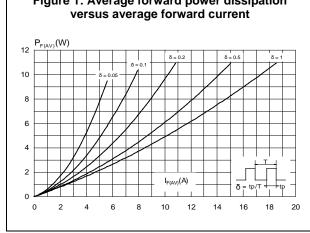


Figure 2: Average forward current versus ambient temperature ($\delta = 0.5$) $I_{F(AV)}(A)$ 20 5 0 0 25 50 75 100 125 150

Figure 3: Relative variation of thermal impedance junction to case versus pulse duration

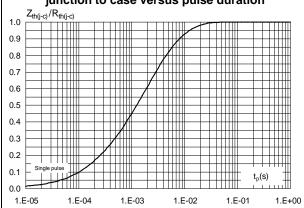


Figure 4: Reverse leakage current versus reverse voltage applied (typical values)

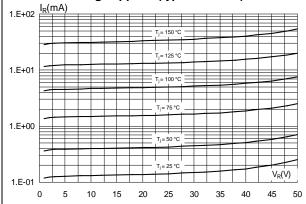


Figure 5: Junction capacitance versus reverse voltage applied (typical values)

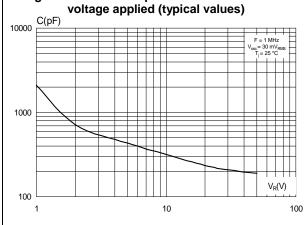
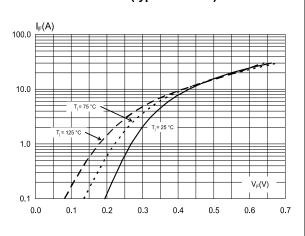
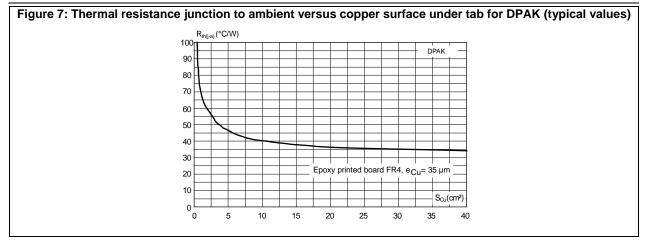


Figure 6: Forward voltage drop versus forward current (typical values)



Characteristics FERD15S50S



FERD15S50S Package information

2 **Package information**

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

- Cooling method: by conduction (C)
- Epoxy meets UL 94,V0

2.1 **DPAK** package information

Figure 8: DPAK package outline

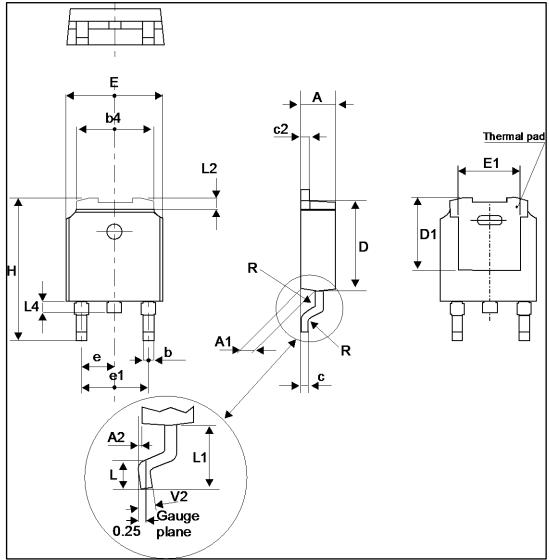
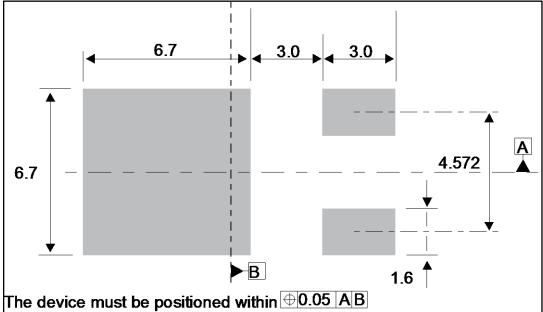


Table 5: DPAK package mechanical data

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		Dime	ensions		
Ref.	Milli	imeters	Inches		
	Min.	Max.	Min.	Max.	
А	2.18	2.40	0.085	0.094	
A1	0.90	1.10	0.035	0.043	
A2	0.03	0.23	0.001	0.009	
b	0.64	0.90	0.025	0.035	
b4	4.95	5.46	0.194	0.215	
С	0.46	0.61	0.018	0.024	
c2	0.46	0.60	0.018	0.023	
D	5.97	6.22	0.235	0.244	
D1	4.95	5.60	0.194	0.220	
E	6.35	6.73	0.250	0.265	
E1	4.32	5.50	0.170	0.216	
е	2.2	86 typ.	0.090	typ.	
e1	4.40	4.70	0.173	0.185	
Н	9.35	10.40	0.368	0.409	
L	1.0	1.78	0.039	0.070	
L2		1.27		0.050	
L4	0.60	1.02	0.023	0.040	
V2	-8°	+8°	-8°	+8°	

Figure 9: DPAK recommended footprint (dimensions in mm)



FERD15S50S Ordering information

3 Ordering information

Table 6: Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
FERD15S50SB-TR	FERD 15S50	DPAK	0.32 g	2500	Tape and reel

4 Revision history

Table 7: Document revision history

Date	Revision	Changes
09-Feb-2017	1	Initial release.

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